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Vishay/Siliconix SUP85N10-10P-GE3

For any questions, you can email us directly: sales@integrated-circuit.com





Vishay Siliconix

N-Channel 100 V (D-S) MOSFET

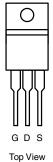
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)	
100	0.010 at V _{GS} = 10 V	85 ^d	77	

FEATURES • Halogen-free Acco

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC





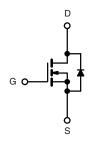


TOP VIE

Ordering Information: SUP85N10-10P-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unless oth	erwise noted)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	I _D	85 ^d	^	
Continuous Diam Current (1j = 173 C)	T _C = 70 °C	d' d'	83		
Pulsed Drain Current		I _{DM}	240	A	
Avalanche Current		I _{AS}	60		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	180	mJ	
M	T _C = 25 °C	В	227 ^b	14/	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	$ P_D$	3.75	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.55	- "C/VV	

Notes:

- a. Duty cycle ≤ 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

Document Number: 64833 S11-2239-Rev. B, 14-Nov-11

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Datasheet of SUP85N10-10P-GE3 - MOSFET N-CH 100V 85A TO220AB

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SUP85N10-10P

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	1 2 7 11					
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.5	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 150 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 20 A		0.0080	0.0100	Ω
	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.0146	0.0185	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		70		S
Dynamic ^b	•					
Input Capacitance	C _{iss}			4660		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 50 V, f = 1 MHz		315		
Reverse Transfer Capacitance	C _{rss}			150		
Total Gate Charge ^c	Qg			77	120	nC
Gate-Source Charge ^c	Q _{gs}	V _{DS} = 50 V, V _{GS} = 10 V, I _D = 75 A		25		
Gate-Drain Charge ^c	Q_{gd}			20		
Gate Resistance	R_{g}	f = 1 MHz	0.25	1.2	2.4	Ω
Turn-On Delay Time ^c	t _{d(on)}			15	25	
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, R_{L} = 0.67 \Omega$		12	20	ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 75$ A, $V_{GEN} = 10$ V, $R_g = 1$ Ω		25	40	
Fall Time ^c	t _f			8	15	
Drain-Source Body Diode Character	istics T _C = 25	${}^{\circ}C_p$				
Continuous Current	Is				85	
Pulsed Current	I _{SM}				240	Α
Forward Voltage ^a	V _{SD}	I _F = 5 A, V _{GS} = 0 V		0.8	1.5	V
Reverse Recovery Time	t _{rr}			74	115	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 5 A, dI/dt = 100 A/μs		6.7	10	Α
Reverse Recovery Charge	Q _{rr}			250	400	nC

Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

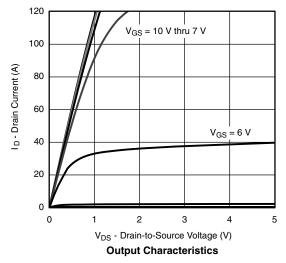
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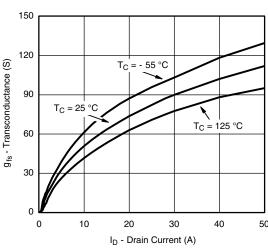


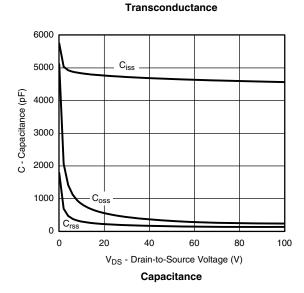


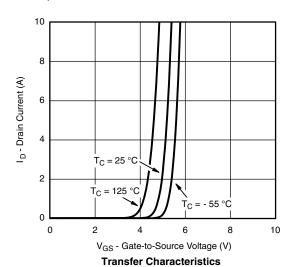
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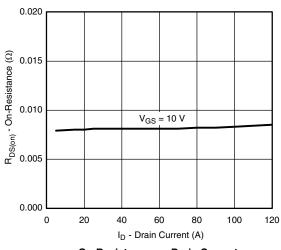
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



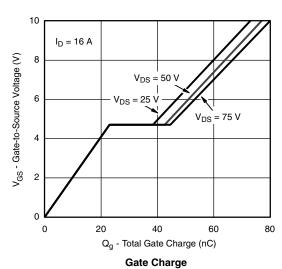








On-Resistance vs. Drain Current



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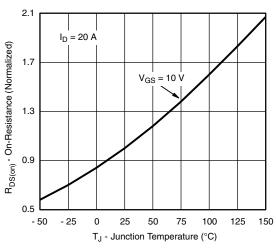
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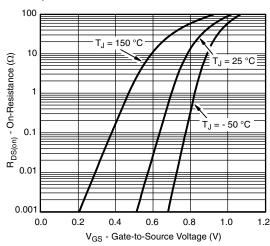
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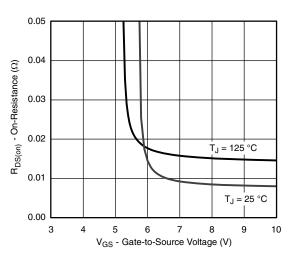




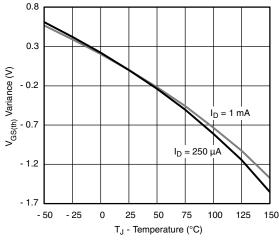
On-Resistance vs. Junction Temperature



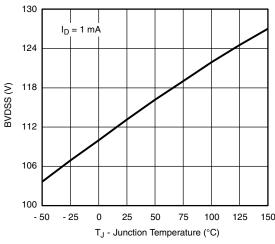
Source-Drain Diode Forward Voltage



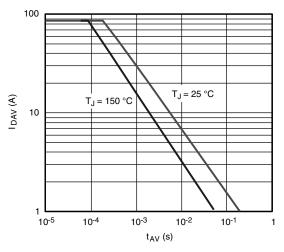
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Drain Source Breakdown Voltage vs. Junction Temperature



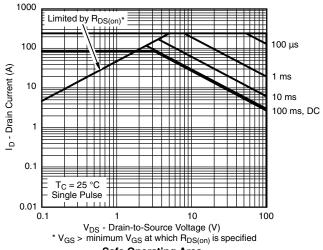
Single Pulse Avalanche Current Capability vs. Time



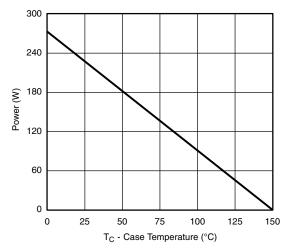


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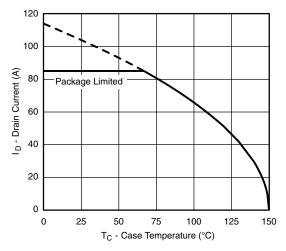
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Current Derating*

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^{*} The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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Datasheet of SUP85N10-10P-GE3 - MOSFET N-CH 100V 85A TO220AB

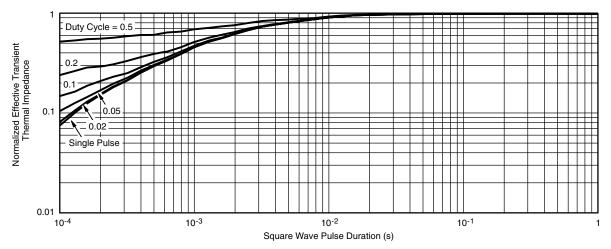
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SUP85N10-10P

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?64833.



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Revision: 13-Jun-16 Document Number: 91000 1